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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/802,811	03/18/2004	Tetsuji Sato	250645US2	5882	
22850	7590 10/03/2005		EXAMINER		
•	•	D, MAIER & NEUSTADT, P.C.	ALEJANDRO MULERO, LUZ L		
1940 DUKE ALEXANDR	SIREEI UA, VA 22314		ART UNIT	PAPER NUMBER	
			1763		

DATE MAILED: 10/03/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)	-
i and a second		10/802,811	SATO, TETSUJI	
Office Action	n Summary .	Examiner	Art Unit	
		Luz L. Alejandro	1763	
The MAILING DAT	TE of this communication app	ears on the cover sheet with the c	correspondence addres	SS
A SHORTENED STATU WHICHEVER IS LONGE - Extensions of time may be avail after SIX (6) MONTHS from the - If NO period for reply is specified - Failure to reply within the set or	ER, FROM THE MAILING DA able under the provisions of 37 CFR 1.13 mailing date of this communication. d above, the maximum statutory period w extended period for reply will, by statute, later than three months after the mailing	IS SET TO EXPIRE 3 MONTH(ATE OF THIS COMMUNICATION 16(a). In no event, however, may a reply be tim 111 apply and will expire SIX (6) MONTHS from 112 cause the application to become ABANDONE 113 date of this communication, even if timely filed	N. nely filed the mailing date of this commu D (35 U.S.C. § 133).	
Status		•	:	
2a)☐ This action is FINA 3)☐ Since this applicat	ion is in condition for allowar	 action is non-final. ace except for formal matters, pro x parte Quayle, 1935 C.D. 11, 45		erits is
Disposition of Claims			•	
4a) Of the above of 5) ☐ Claim(s) is/6) ☑ Claim(s) <u>1-6</u> is/are 7) ☐ Claim(s) is/	e rejected.		· .	
Application Papers	·			
9) ☐ The specification is	s objected to by the Examine	r.	*	
Applicant may not re Replacement drawin	equest that any objection to the ong sheet(s) including the correct	epted or b) objected to by the I drawing(s) be held in abeyance. See ion is required if the drawing(s) is ob aminer. Note the attached Office	e 37 CFR 1.85(a). jected to. See 😿 CFR 1	
Priority under 35 U.S.C. §	119		*	
12) Acknowledgment is a) All b) Some 1. Certified copies of the application is	s made of a claim for foreign * c) None of: pies of the priority documents pies of the priority documents ne certified copies of the prior from the International Bureau	s have been received in Applicati ity documents have been receive	ion No ed in this National Sta	ge
Attachment(s) 1) Notice of References Cited (2) Notice of Draftsperson's Pat 3) Information Disclosure State Paper No(s)/Mail Date	ent Drawing Review (PTO-948) ment(s) (PTO-1449 or PTO/SB/08)	4) Interview Summary Paper No(s)/Mail D 5) Notice of Informal F 6) Other:		2)

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DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hirayama et al., WO 00/24047 in view of Koshimizu, U.S. Patent 5,997,687.

Hirayama et al. shows the invention substantially as claimed including a plasma processing apparatus comprising: a vacuum chamber accommodating therein a substrate 104 to be processed, allowing an inner space of the vacuum chamber to be maintained at a vacuum level; a first electrode 104 (see fig. 8) fixedly disposed at a location in the vacuum chamber; a shower plate 114 installed in the vacuum chamber and facing the first electrode, the shower plate being vertically movable so as to vary a distance between the first electrode and the shower plate; a driving mechanism 109 for vertically moving the shower plate, the driving mechanism being installed outside the vacuum chamber; a bellows unit 106 for air-tightly sealing an opening, the bellows unit having a frame-shaped member (for example, 102 or 110) connected to the driving mechanism, wherein the opening, through which the shower plate is driven by the driving mechanism from the outside of the vacuum chamber, is provided at the vacuum chamber; an electrode supporting member 107 for connecting the frame-shaped member to the shower plate, the shower plate being installed in the vacuum chamber;

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and a high frequency power source (for example, 404) for generating plasma by supplying a high frequency power between the first electrode and the second electrode (see abstract and figs. 2-3, 5, and 8).

Hirayama et al. does not expressly disclose the shower plate being a second electrode. Koshimizu discloses a shower plate 112 that is also a second electrode for generating plasma and has a high frequency power source 128 for supplying plasma (see fig. 1 and its description). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the apparatus of Hirayama et al. so as to have the shower plate as a second electrode because such an apparatus will be capable of effectively and efficiently supplying a uniform concentration of plasma throughout the chamber.

With respect to claims 2-3, note that in the apparatus of Hirayama et al. modified by Koshimizu the first electrode and the second electrode are a lower electrode and an upper electrode, and the upper electrode is supported from underneath the lower electrode.

Concerning claim 4, note that Hirayama et al. does not expressly disclose an exhaust ring for uniformly exhausting the vacuum chamber. Koshimizu discloses an exhaust ring 117 for uniformly exhausting the vacuum chamber (see col. 5-lines 15-20). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the apparatus of Hirayama et al. so as to include the exhaust ring of Koshimizu because such a configuration allows for the discharge flow to be straightened thereby improving exhaustion.

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Regarding claim 5, note that the electrode supporting member includes a cylindrical member 107 or 121 for protecting an inner wall of the vacuum chamber.

Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Hirayama et al., WO 00/24047 in view of Koshimizu, U.S. Patent 5,997,687 as applied to claims 1-5 above, and further in view of Denpoh, US 2003/0062128 or Tanaka et al., US 2004/0020599.

Hirayama et al. and Koshimizu are applied as above but do not expressly disclose a substrate supporting member for supporting the substrate to be processed above the lower electrode, the substrate supporting member being vertically movable by the driving mechanism to pass through the lower electrode. Denpoh discloses a substrate supporting member 17 for supporting the substrate to be processed above the lower electrode, the substrate supporting member being vertically movable by a driving mechanism to pass through the lower electrode (see fig. 1 and its description). Furthermore, Tanaka et al. discloses a substrate supporting member 16 for supporting the substrate to be processed above the lower electrode, the substrate supporting member being vertically movable by a driving mechanism to pass through the lower. electrode (see fig. 6 and its description). In view of these disclosures, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the apparatus of Hirayama et al. modified by Koshimizu so as to include the substrate supporting member as suggested by Denpoh or Tanaka et al. because such a supporting structure allows for easy movement and support of the wafer.

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Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Luz L. Alejandro whose telephone number is 571-272-1430. The examiner can normally be reached on Monday to Thursday from 7:30 to 6:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on 571-272-1435. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Edz L. Alejandro Primary Examiner Art Unit 1763

September 29, 2005